



### **CCP Contact Probes - History**

2020 New Product Line: High Speed Network Cable

2020 Korea Subsidiary established.

2019 Japan Singapore Sub and India Office established.

2018 Germany Subsidiary established.

2016 Industrial Connector & Crown Spring Connector.

2014 CCP US Subsidiary established.

2012 Set up 100k class clean room production line.

2006 IC Testing

2003 Listed in Taiwan Stock Market (TW.6217).

2002 Pogo Pin Connector

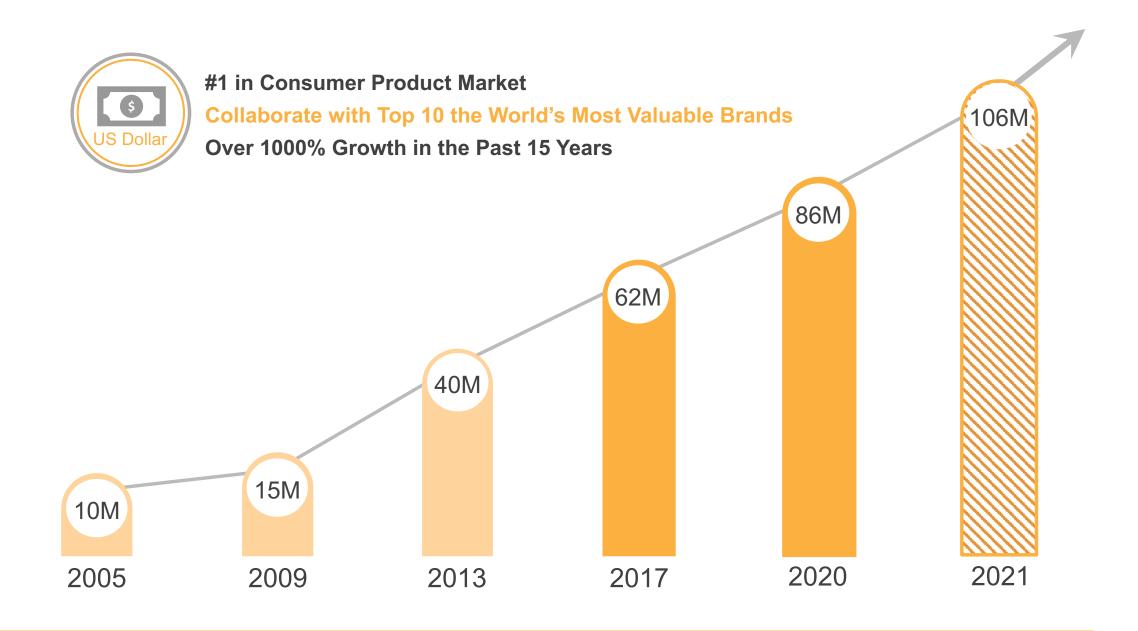
2001 Dongguan CCP Contact Probes Co., Ltd established.

1986 ICT Testing

1986 CCP Contact Probes Co., Ltd. Established.

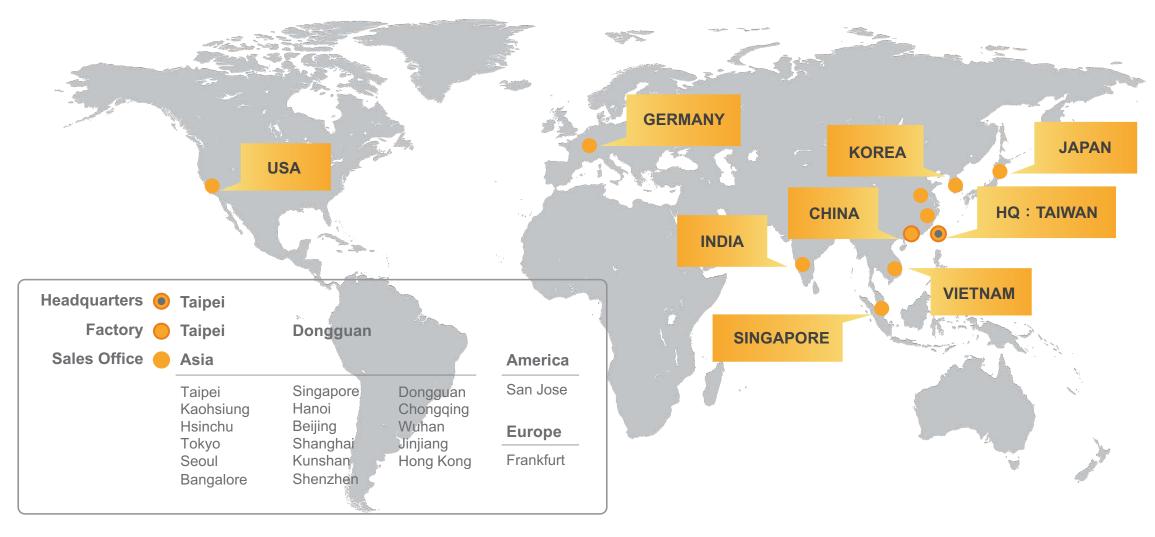


#### **CCP Contact Probes - Growth**





#### **CCP Contact Probes - Worldwide**

























### **CCP Contact Probes - Product Portfolio**



Testing Solution

**Fine Pitch** 

IC Testing Probe PCB Testing Probe Testing Socket



Pogo Pin Connector

1A~13A

Pogo Pin Conn. Waterproof Conn. Magnetic Conn.



High Current Connector

13A~250A

Electronic Vehicle High Current Conn.



Medical Connector

**Environmental Sensitivity** 

Circular Conn.
Endoscope Conn.



High Speed Cable

25Gbps~100Gbps

Server Switch Telecom



Industrial Solution

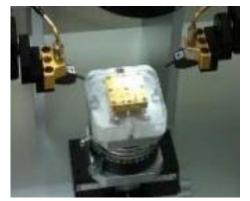
**Extreme Environment** 

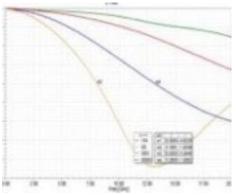
Aerospace Military Transportation



# **Core Advantages**

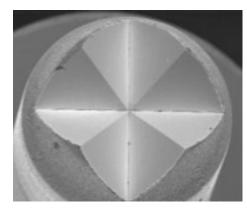
#### High Frequency Simulation



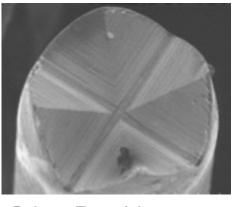


HFSS

#### Mirror Process



CCP's Product



Other Provider

#### **Material Development**

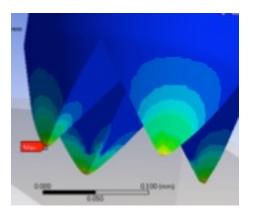




Plating Lab

Self-owned Plating Factory

#### Finite Element Analysis



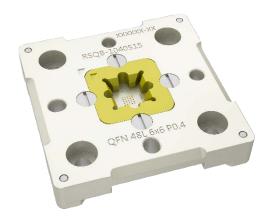
**ANSYS** 



### **Testing Solution Product Line**



**IC Package Test** 



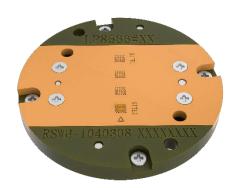
**Memory Test** 



**Burn-In Test** 



**WLCSP Test** 



**High Frequency Test** 



**Battery Test** 





# **Testing Solution - IC Test Probe**



**General Final Test** 



**Burn-In Test** 



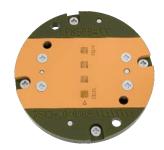
**Memory Test** 



High Frequency Test



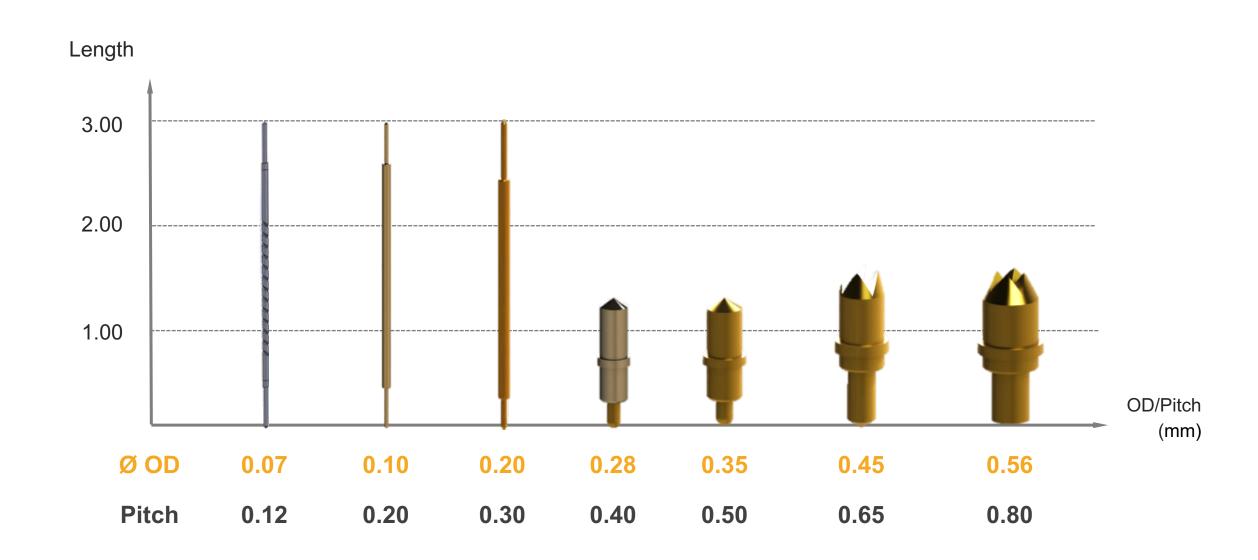
Wafer Level Test



Fine Pitch Test

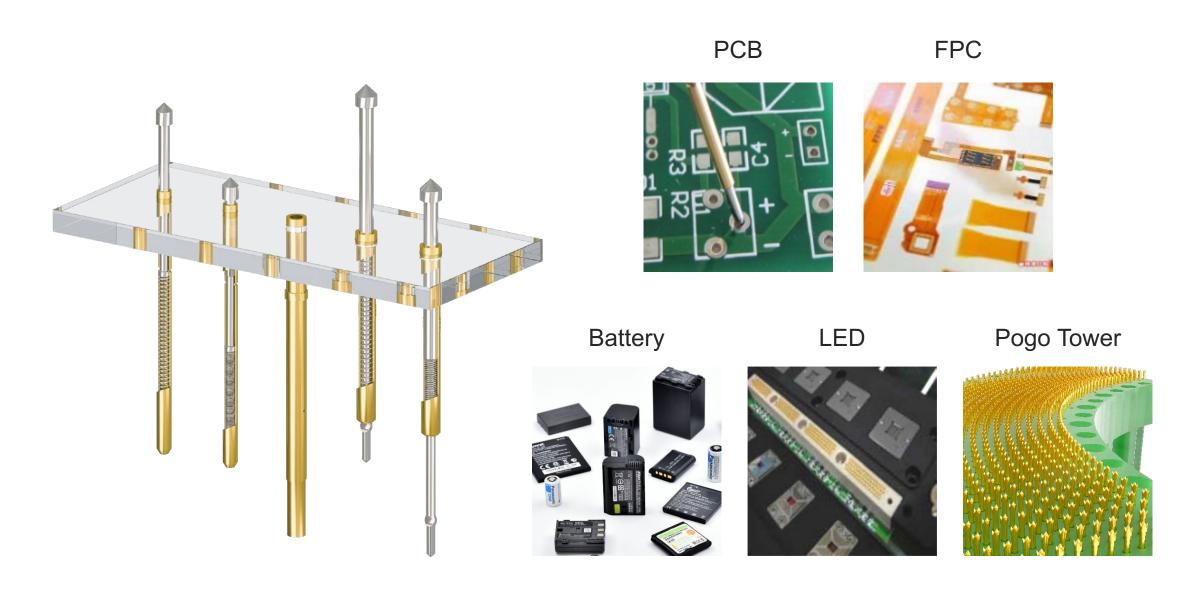


# **Testing Solution - Testing Probe**





# **Testing Solution - ICT Test Probe**



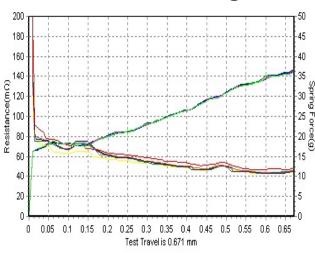


### **Testing Solution - High Current Probe**

#### Patent No. **M453149**

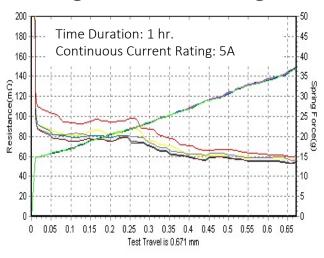


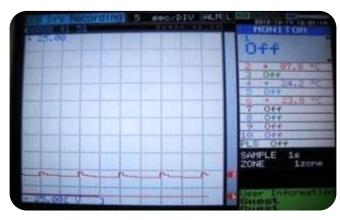
#### **Normal Testing**



CCP Concentric Pin	
Stroke	0.60mm
Contact force	30 g (Adjustable)
Durability	Contacts : >30k
Pitch	0.650mm
DC resistance	< 60mΩ
<b>Current Rating</b>	5A

#### **High Current Testing**

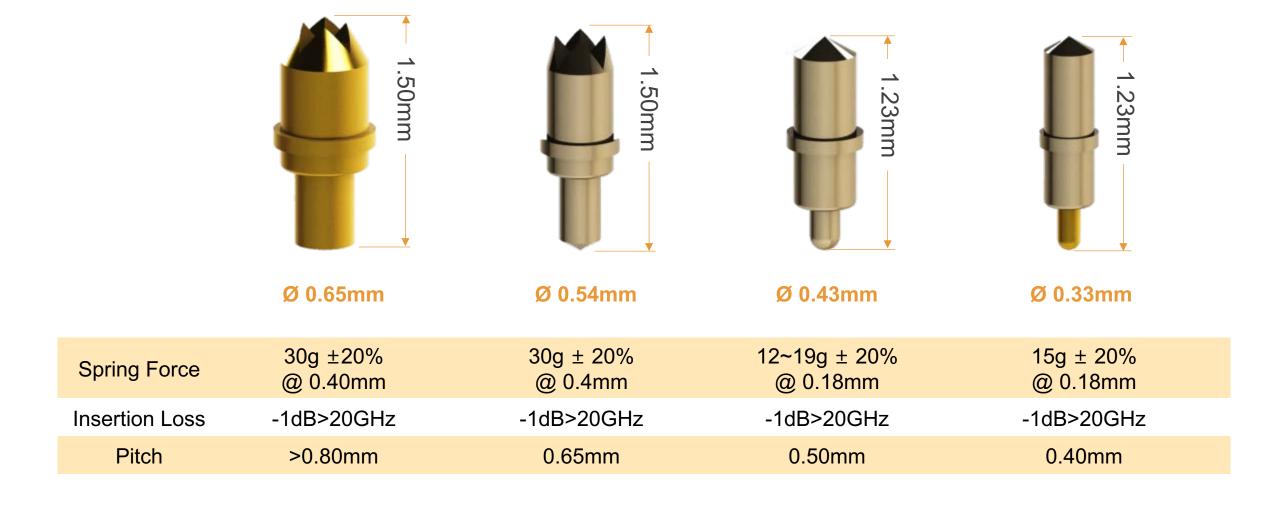




Temperature Record



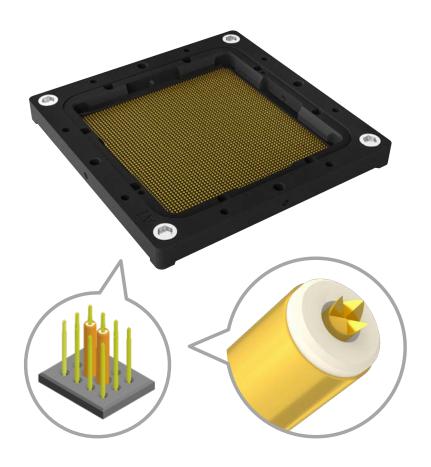
# Testing Solution - High Frequency Probes





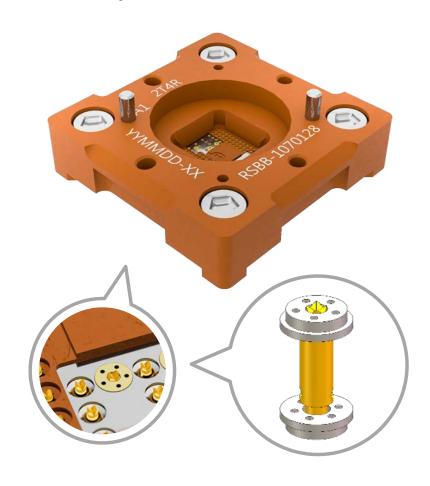
# **Testing Solution - High Frequency Socket**

**5G IC**Coaxial Probe Socket



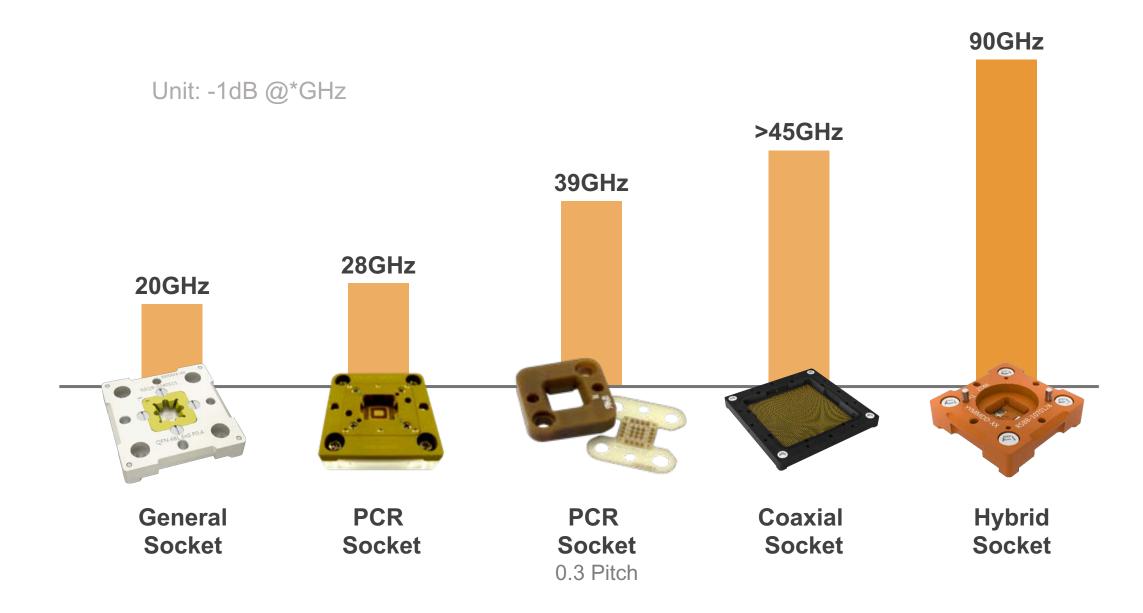
ADAS

Hybrid Coaxial Socket





### **Testing Solution - High Frequency Socket**



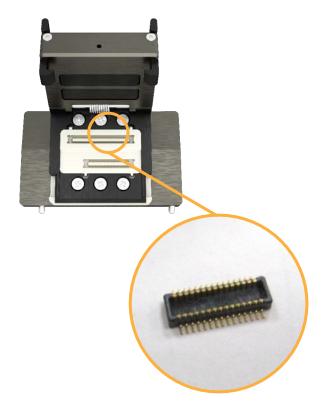


### **Testing Solution - Fine Pitch Test Fixture**

#### Dual-Side Pogo Socket

Min Pitch: 0.2

Mechanical Life: 200k

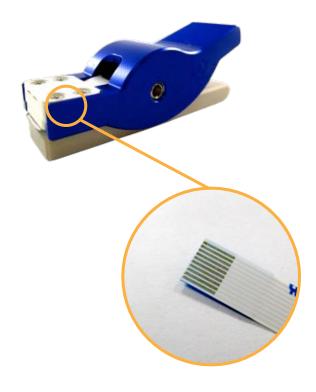


Device Under Test
Fine Pitch Connector

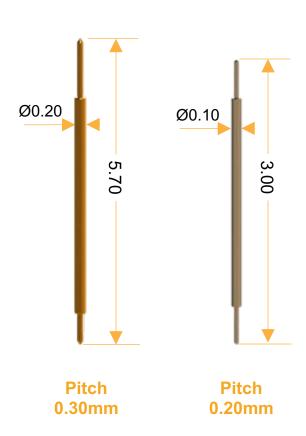
#### Clip Pogo Socket

Min Pitch: 0.2

Mechanical Life: 200k



Device Under Test FPC / FFC Gold Finger





# **Testing Solution - IC Final Test Socket**

**BGA** 



QFN



**Memory Test** 

DDR 1~4 eMCP Flash





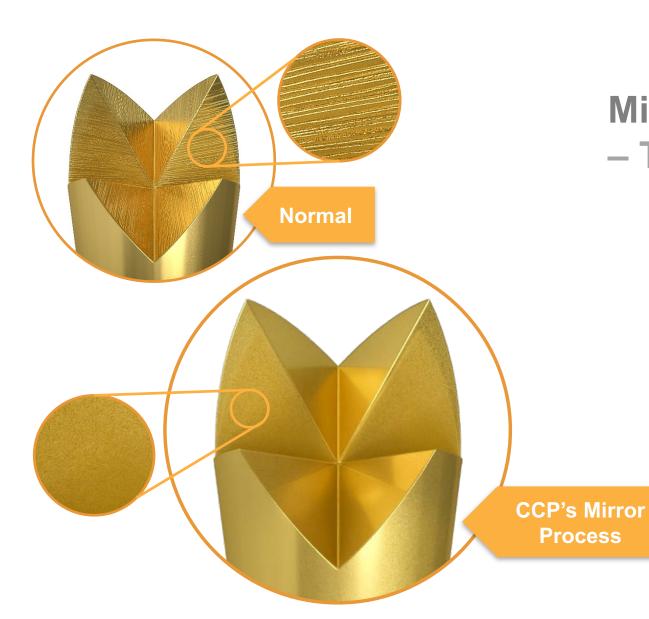
Clamping Lid
QFN QFP
<200 pins



Knob Lid
All Kind
>200 pins



### **Testing Solution - Mirror Process**



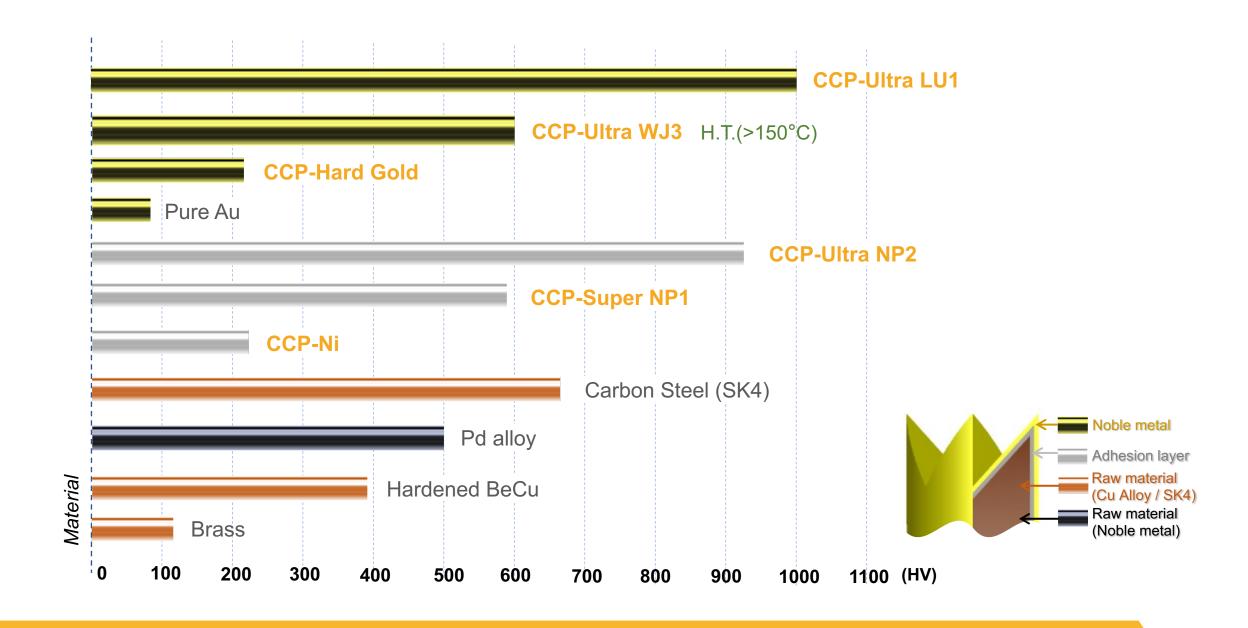
#### **Mirror Process**

#### The Best Probe Protector

- The Mirror Process make the surface as smooth as mirror so that solder splashes won't attach on the probe tip. This, in turn, decreases your probe cleaning frequency, as well as machine down time significantly.
- Pin durability increase 1.3~1.5 times as compared to normal process.

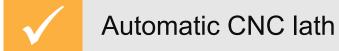


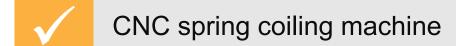
### **Testing Solution - Material Development**

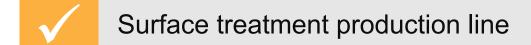


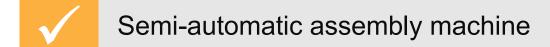


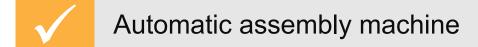
# **Testing Solution - Integrated Manufacturing**

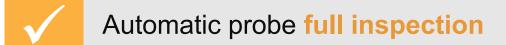


























### **Testing Capability - Test Equipment**

# **Turning Parts Surface Inspection**



**Optical Profiler** 

Surface Roughness Inspection

#### **Plating Layer Inspection**



**Nanoindenter** 

- Hardness measurement
- Adhesion Test



**FE-SEM and EDS** 

- Surface profile observation
- Material analysis



### **Testing Capability - Test Equipment**

#### **Electrical Performance**



Network Analyzer



VNA Vector Network Analyzer)



High Current Power Supply & Electronic Load



Contact Resistance Tester



RCA Tape Abrasion Tester

#### **Mechanical Performance**



Safety Comprehensive Analyzer

Mechanical

Vibration/Shock



Automatic Insertion Force Tester



Durability Cycling Machine



Other

3D laser scanning microscope

**Hot-Air Reflow** 

machine



X-ray



Electrochemical workstation





Oven

**Waterproof test** 

machine

Flush test

chamber



Thermal shock test machine



Salt spray test machine



Temperature & humidity test machine



Terminal cross section analyzer



#### **Create Value for Customers**



OUR VALUE Solution Service
Engineering Service
Design for Manufacturing
Customization
Flexible Production.
Local and Instant Support



### **Quality Management**

# **Quality System**

ISO 9001:2015

**Quality Management Systems** 

ISO 14001: 2015

**Environment Management Systems** 

QC 080000

IATF 16949:2016

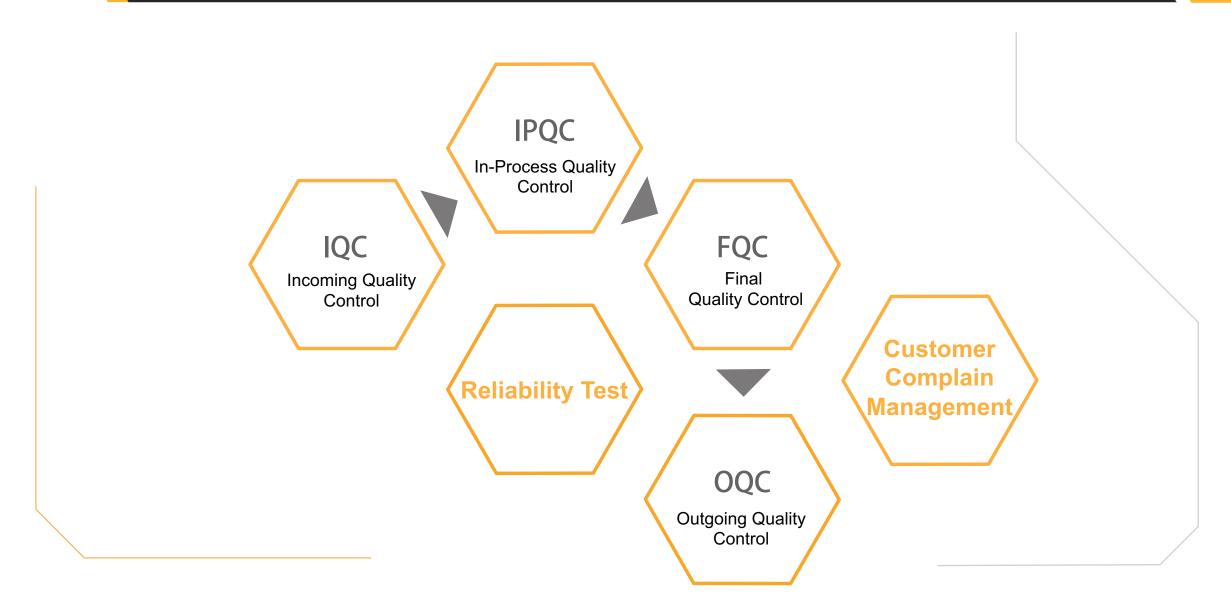
Hazardous Substance Process Management

**Automotive Quality Management System** 

ISO 13485:2016

Medical Devices Quality Management Systems

# **Quality Assurance**





### **Verification Ability**

# Testing Items

#### Environmental

Waterproof
Humidity Test
Salt Spray
Thermal Impact
Resist. to Solder Heat
Vibration

#### Electrical

Contact Resistance Insulation HIPOT Rated Current

#### Mechanical

Retention Force
Life Cycle
Vibration
Mechanical Shock

#### Other

Drop
Soldering Side Force
Solderability



# Testing Equipment

#### **Rated Current**

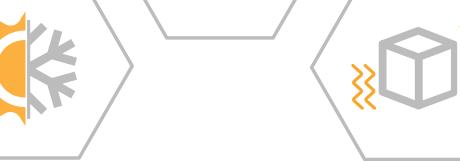
Max Rating: 1000Amp

#### Waterproof

Test Level: IPX7 Up









#### Thermal Impact

Range : -60~120°C Resolution: 0.01°C

#### Vibration

Frequency: 3500Hz Max. Acceleration: 50G Max.



#### Certificate



ISO 9001 ISO 13485 ISO 14001 ISO 14064 IATF 16949 IECQ QC080000













#### **Social Responsibility**



Summer camp for employees' children





Home visit to employees around the world





CCP offers tuition scholarship for employees' children

